

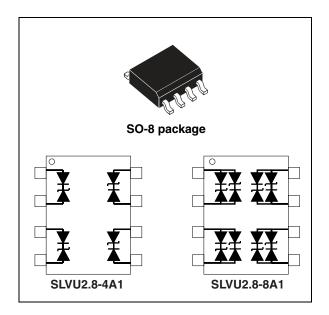
Low voltage unit for Gigabit Ethernet protection

Features

- Peak pulse current : I_{PP} = 30 A 8/20 µs
- Low capacitance : C_{tvp} = 1.5 pF
- Stand-off voltage : V_B = 2.8 V
- Low leakage current : I_{Rmax} = 0.2 µA
- ECOPACK[®]2 compliant component
- IEC 61000-4-5 (1kV 42 Ω 24 A) compliant at T_i = 150 °C

Complies with the following standards

- IEC 61000-4-2 level 4
 - 15 kV (air discharge)
 - 8 kV (contact discharge)
- IEC 61000-4-4 level 4
 - ± 2 kV 40 A (5/50 ns)
- IEC 61000-4-5 level 2
 - ±1 kV 42 Ω
- IEEE 802.3ab and 802.3at compatible on both receiver (4 Vmax) and driver side (3.6 Vmax)
- MIL STD 883G Method 3015-7
 - 25 kV (human body model)



Description

The SLVU2.8 series has been designed to protect Ethernet line. Its low capacitance makes it compatible with Gigabit Ethernet.

SLVU2.8-4A1 is designed to be compatible with Gigabiit Ethernet and Gigabit PoE by using two SO-8 packages and can be used on 10/100 Mbps Ethernet by using a single device.

SLVU2.8-8A1 is designed to be compatible with Gigabiit Ethernet and Gigabit PoE by using a single SO-8 package.

Surge capability is compatible with IEC 61000-4-5 class 2 (1 kV, 42 Ω , 24 A).

Packaged in SO-8, the SLVU2.8 is a flow-through design in order to minimize trace inductances. Footprint is in accordance with IPC 7531 standard.

1 Characteristics

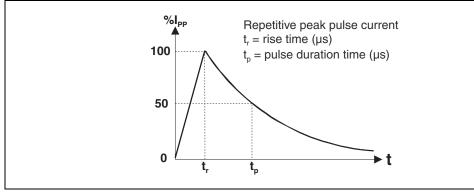
Table 1. Absolute ratings ($T_{amb} = 25 \ ^{\circ}C$)

Symbol	Parameter	Value	Unit
P _{PP}	Peak pulse power (8/20 µs)	600	W
I _{PP}	Peak pulse current (8/20 µs)	30	А
T _{stg}	Storage temperature range	-65 to + 150	°C
Tj	Maximum junction temperaturee	-55 to + 150	°C
TL	Maximum lead temperature for soldering during 10 s.	260	°C

Table 2. Electrical characteristics values ($T_{amb} = 25 \ ^{\circ}C$)

	I _{RM} @V _{RM}			V _{CL @} I _{PP} 8/20 µs		V _{CL @} I _{PP} 8/20 µs		C I/O to I/O		
Order code	typ.	max.	max. 85 °C		max.		max.		typ.	max.
	nA	μA	μA	v	v	Α	v	Α	pF	pF
SLVU2.8-4A1	2	0.2	1	2.8	15	24	12	12	1.5	2.5
SLVU2.8-8A1	2	0.2	1	2.8	15	24	12	12	3	5

Figure 1. Pulse waveform





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Figure 2. Relative peak pulse power versus initial junction temperature

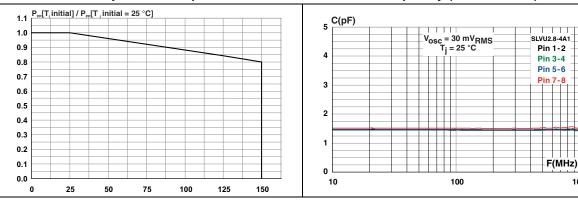
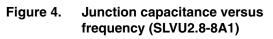
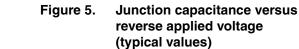


Figure 3.





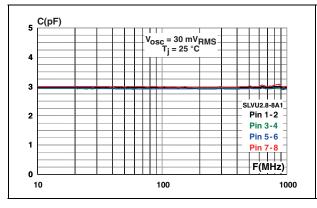
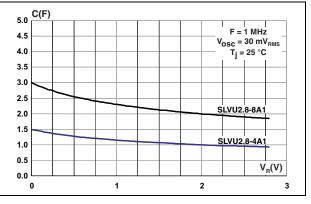
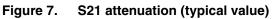


Figure 6. Leakage current versus junction temperature (typical values)



Junction capacitance versus

frequency (SLVU2.8-4A1)



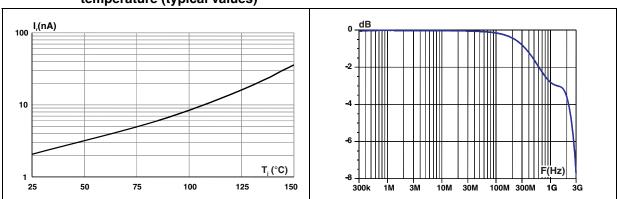
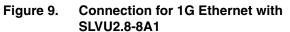
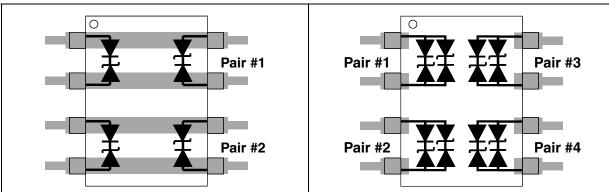
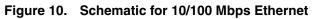


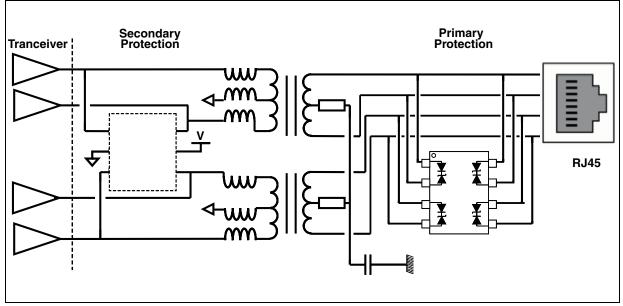


Figure 8. Connection for 10/100 Mbps Ethernet with SLVU2.8-4A1











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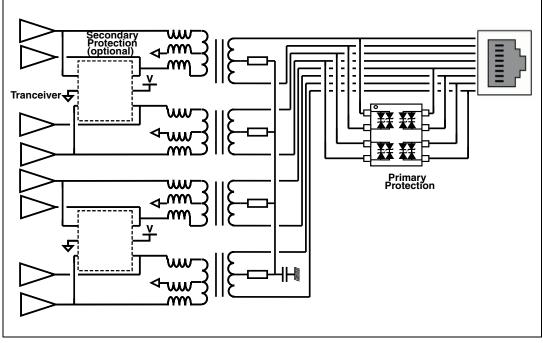


Figure 11. Schematic for 1 Gbps Ethernet

1. For further information, refer to application note : AN3007

2 Ordering information scheme

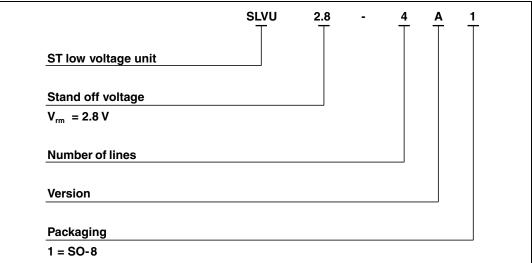


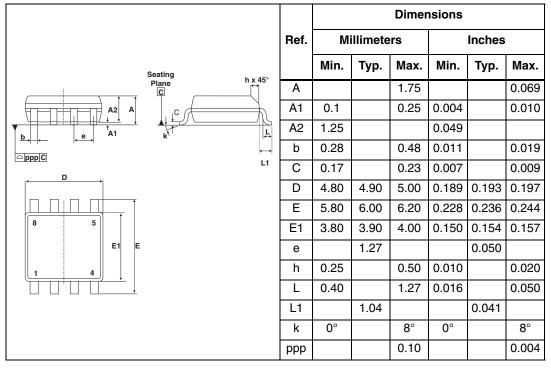
Figure 12. Ordering information scheme

3 Package information

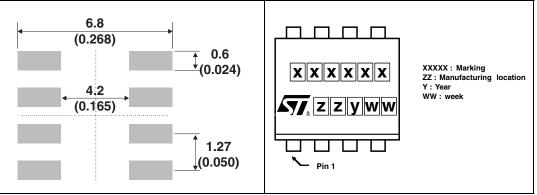
- Case: JEDEC SO-8 molded plastic over planar junction
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Flammability: Epoxy is rated UL94V-0
- RoHS package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 3. SO-8 dimensions









4 Ordering information

Table 4. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
SLVU2.8-4A1	SLVU284	SO-8	78 mg	2500	Tape and reel
SLVU2.8-8A1	SLVU288	SO-8	78 mg	2500	Tape and reel

5 Revision history

Table 5. Document revision history

Date	Revision	Changes
01-Sep-2009	1	Initial release.
31-May-2011	2	Updated Ethernet standard compatibility on the cover page.



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